

Polar™ HiPerFET™ **Power MOSFETs**

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode

IXFV36N50PS IXFV36N50P IXFH36N50P IXFT36N50P

V_{DSS} 500V 36A D25 $170 \mathrm{m}\Omega$ $\boldsymbol{R}_{\text{DS(on)}}$ <u>≤</u> 200ns

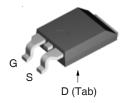


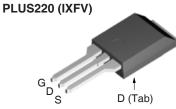


| Symbol | Test Conditions | Maximum Ratings | | |
|-------------------------------------|--|-------------------|-------------|--|
| V _{DSS} | $T_{_{\mathrm{J}}} = 25^{\circ}\text{C to } 150^{\circ}\text{C}$ | 500 | V | |
| V _{DGR} | $T_{_J} = 25^{\circ}\text{C} \text{ to } 150^{\circ}\text{C}, R_{_{GS}} = 1\text{M}\Omega$ | 500 | V | |
| $V_{\rm gss}$ | Continuous | ±30 | V | |
| V _{GSM} | Transient | ±40 | V | |
| I _{D25} | $T_{c} = 25^{\circ}C$ | 36 | А | |
| I _{DM} | $T_{\rm c} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$ | 90 | Α | |
| I _A E _{AS} | $T_{c} = 25^{\circ}C$ $T_{c} = 25^{\circ}C$ | 36 1.5 | A J | |
| dv/dt | $I_{S} \leq I_{DM}, V_{DD} \leq V_{DSS}, T_{J} \leq 150^{\circ}C$ | 10 | V/ns | |
| P_{D} | T _C = 25°C | 540 | W | |
| T _J | | -55 +150 | °C | |
| T _{JM} T _{stg} | | 150 -55 +150 | °C °C | |
| T_{L} | 1.6mm (0.062 in.) from Case for 10s | 300 | °C | |
| T _{SOLD} | Plastic Body for 10s | 260 | °C | |
| \mathbf{M}_{d} | Mounting Torque (TO-247) | 1.13/10 | Nm/lb.in. | |
| F_c | Mounting Force (PLUS220) | 20120 /4.527 | N/lb. | |
| Weight | PLUS220 TO-268 TO-247 | 4.0 4.0 6.0 | g g g | |

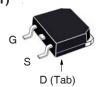
| Symbol (T _J = 25°C U | Test Conditions Unless Otherwise Specified) | Charac Min. | teristic Typ. | Values Max. | |
|------------------------------------|---|----------------|------------------|----------------|--------------------------|
| BV _{DSS} | $V_{GS} = 0V, I_D = 250\mu A$ | 500 | | | V |
| V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 4mA$ | 3.0 | | 5.0 | V |
| I _{GSS} | $V_{GS} = \pm 30V, V_{DS} = 0V$ | | | ±100 | nA |
| I _{DSS} | $V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 125^{\circ}C$ | | | | μ Α μ Α |
| R _{DS(on)} | V _{GS} = 10V, I _D = 0.5 • I _{D25} , Note 1 | | | 170 | mΩ |

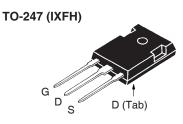












| G | = Gate | D | = | Drain |
|---|----------|-----|---|-------|
| S | = Source | Tab | = | Drain |

Features

- Low Package Inductance
- Fast Intrinsic Rectifier
- Low R_{DS(on)} and Q_G

Advantages

- High Power Density
- Easy to Mount
- Space Savings



| • | | Charac | acteristic Values | | |
|------------------------|----|---|-------------------|------|-----------|
| $(T_{J} = 25^{\circ})$ | CU | nless Otherwise Specified) | Min. | Тур. | Max. |
| g_{fs} | | $V_{DS} = 20V, I_{D} = 0.5 \bullet I_{D25}, \text{ Note 1}$ | 23 | 36 | S |
| C _{iss} |) | | | 5500 | pF |
| \mathbf{C}_{oss} | } | $V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$ | | 510 | pF |
| C _{rss} | J | | | 40 | pF |
| t _{d(on)} |) | Resistive Switching Times | | 25 | ns |
| t _r | Ţ | $V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$ | | 27 | ns |
| t _{d(off)} | (| | | 75 | ns |
| t _f | J | $R_{G} = 3\Omega$ (External) | | 21 | ns |
| $\mathbf{Q}_{g(on)}$ |) | | | 93 | nC |
| \mathbf{Q}_{gs} | } | $V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 0.5 \cdot I_{D25}$ | | 30 | nC |
| \mathbf{Q}_{gd} | J | | | 31 | nC |
| R _{thJC} | | | | | 0.23 °C/W |
| R _{thCS} | | (TO-247 & PLUS220) | | 0.25 | °C/W |

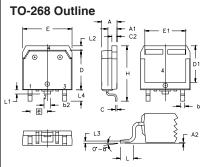
Source-Drain Diode

| Symbol (T _J = 25°C U | Test Conditions nless Otherwise Specified) | Chara Min. | cteristic \ Typ. | /alues Max. | |
|---|--|---------------|---------------------|----------------|---------------|
| I _s | $V_{GS} = 0V$ | | | 36 | Α |
| I _{SM} | Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$ | | | 144 | Α |
| V _{SD} | $I_F = I_S$, $V_{GS} = 0V$, Note 1 | | | 1.5 | V |
| $\left\{ egin{array}{ll} \mathbf{t}_{rr} & \\ \mathbf{Q}_{RM} & \\ \mathbf{I}_{RM} & \end{array} ight\}$ | $I_F = 25A$, -di/dt = 100A/ μ s $V_R = 100V$, $V_{GS} = 0V$ | | 0.8 8.0 | 200 | ns μC Α |

Note 1. Pulse test, $t \le 300\mu s$, duty cycle, $d \le 2\%$.



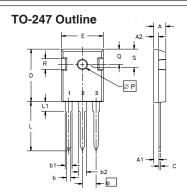
IXFH36N50P IXFV36N50P IXFT36N50PS



Terminals: 1 - Gate 2,4 - Drain

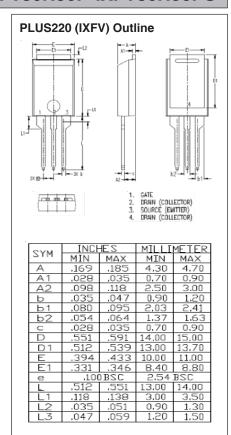
| 3 - | Source |
|-----|--------|
| | |

| Ovite | INCHES MILLIMETERS | | | /FTFRS |
|-------|--------------------|------|----------|--------|
| MYZ | MIN | MAX | MIN | MAX |
| Α | .193 | .201 | 4.90 | 5.10 |
| A1 | .106 | .114 | 2.70 | 2.90 |
| A2 | .001 | .010 | 0.02 | 0.25 |
| b | .045 | .057 | 1.15 | 1.45 |
| b2 | .075 | .083 | 1.90 | 2.10 |
| С | .016 | .026 | 0.40 | 0.65 |
| C2 | .057 | .063 | 1.45 | 1.60 |
| D | .543 | .551 | 13.80 | 14.00 |
| D1 | .488 | .500 | 12.40 | 12.70 |
| Е | .624 | .632 | 15.85 | 16.05 |
| E1 | .524 | .535 | 13.30 | 13.60 |
| е | .215 | BSC | 5.45 BSC | |
| Н | .736 | .752 | 18.70 | 19.10 |
| L | .094 | .106 | 2.40 | 2.70 |
| L1 | .047 | .055 | 1.20 | 1.40 |
| L2 | .039 | .045 | 1.00 | 1.15 |
| L3 | .010 BSC | | 0.25 | BSC |
| L4 | .150 | .161 | 3.80 | 4.10 |



Terminals: 1 - Gate 2 - Drain 3 - Source

| Dim. | Millimeter | | Inc | hes |
|----------------|------------|-------|-------|-------|
| | Min. | Max. | Min. | Max. |
| Α | 4.7 | 5.3 | .185 | .209 |
| A, | 2.2 | 2.54 | .087 | .102 |
| A ₂ | 2.2 | 2.6 | .059 | .098 |
| b | 1.0 | 1.4 | .040 | .055 |
| b, | 1.65 | 2.13 | .065 | .084 |
| b ₂ | 2.87 | 3.12 | .113 | .123 |
| С | .4 | .8 | .016 | .031 |
| D | 20.80 | 21.46 | .819 | .845 |
| E | 15.75 | 16.26 | .610 | .640 |
| е | 5.20 | 5.72 | 0.205 | 0.225 |
| L | 19.81 | 20.32 | .780 | .800 |
| L1 | | 4.50 | | .177 |
| ØP | 3.55 | 3.65 | .140 | .144 |
| Q | 5.89 | 6.40 | 0.232 | 0.252 |
| R | 4.32 | 5.49 | .170 | .216 |
| S | 6.15 | BSC | 242 | BSC |



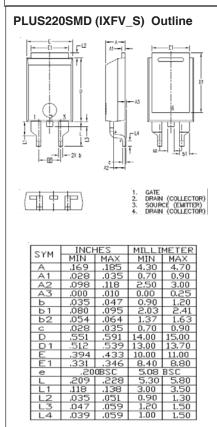




Fig. 1. Output Characteristics @ T_J = 25°C

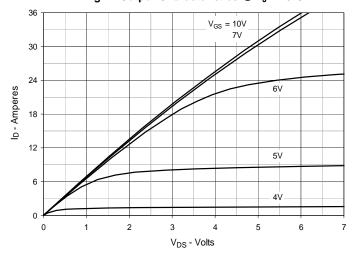


Fig. 2. Extended Output Characteristics @ T_J = 25°C

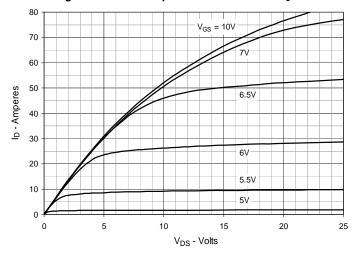


Fig. 3. Output Characteristics @ T_J = 125°C

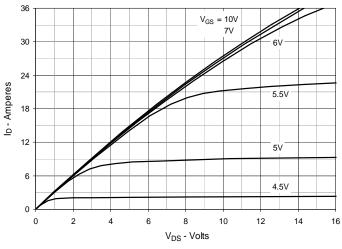


Fig. 4. $R_{DS(on)}$ Normalized to I_D = 18A Value vs. Junction Temperature

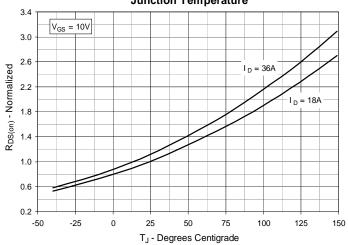


Fig. 5. $R_{DS(on)}$ Normalized to I_D = 18A Value vs.

Drain Current

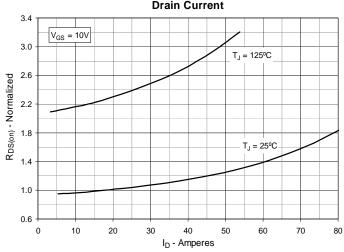
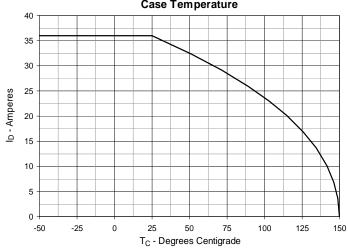


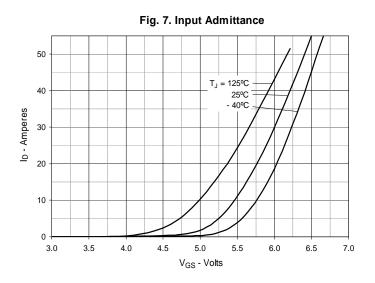
Fig. 6. Maximum Drain Current vs.

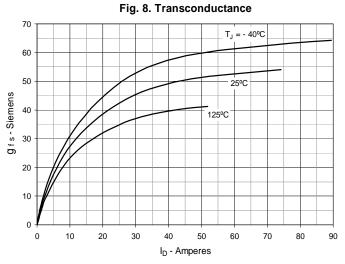
Case Temperature

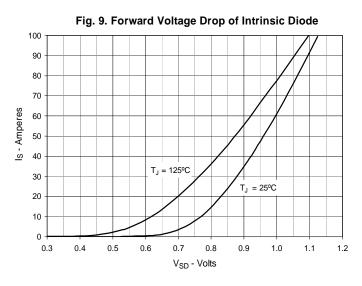


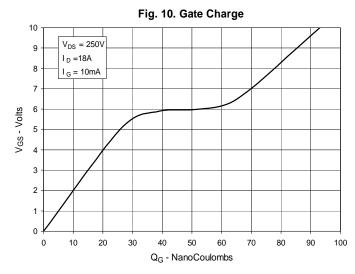
IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

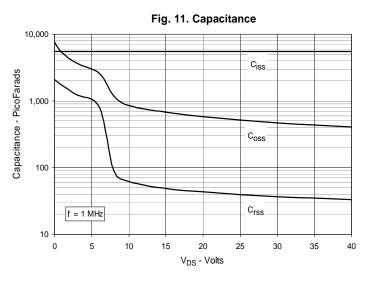


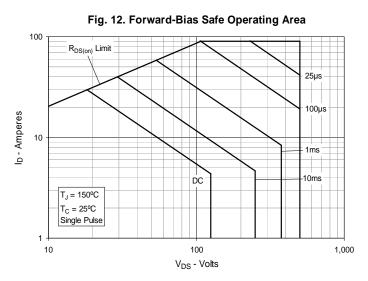




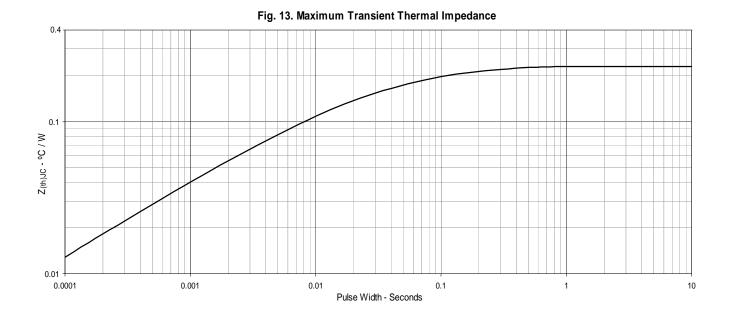












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